

Description

super junction MOSFET family that is utilizing charge balance technology for extremely low on-resistance and low gate charge performance.

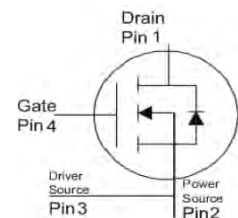
WMR80N65C4 is suitable for applications which require superior power density and outstanding efficiency.

Features

- $V_{DS}=700V @ T_{j,max}$
- Typ. $R_{DS(on)}=0.033\Omega$
- 100% UIS tested
- Pb-free plating, Halogen free

Applications

LED Lighting, Charger, Adapter, PC, LCD TV, Server



Absolute Maximum Ratings

Parameter	Symbol	WMR80N65C4	Unit
Drain-source voltage	V_{DSS}	650	V
Continuous drain current ¹⁾ ($T_C = 25^\circ C$)	I_D	80	A
		($T_C = 100^\circ C$)	45
Pulsed drain current ²⁾	I_{DM}	245	A
Gate-source voltage	V_{GS}	± 30	V
Avalanche energy, single pulse ³⁾	E_{AS}	850	mJ
Avalanche energy, repetitive ²⁾	E_{AR}	1.2	mJ
Avalanche current, repetitive ²⁾	I_{AR}	6	A
Power dissipation ($T_C = 25^\circ C$)	P_D	410	W
		- Derate above $25^\circ C$	3.28
Operating and storage temperature range	T_j, T_{stg}	-55 to +150	$^\circ C$
Continuous diode forward current	I_S	80	A
Diode pulse current	$I_{S,pulse}$	245	A

Thermal Characteristics

Parameter	Symbol	WMR80N65C4	Unit
Thermal resistance, junction-to-case	$R_{\theta JC}$	0.35	$^\circ C/W$
Thermal resistance, junction-to-ambient	$R_{\theta A}$	62	$^\circ C/W$



WMR80N65C4

Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	B _{VDS}	V _{GS} =0 V, I _D =1 mA	650	-	-	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =0.25mA	2	3	4	V
Drain cut-off current	I _{DSS}	V _{DS} =650 V, V _{GS} =0V, T _j = 25°C T _j = 125°C	- -	- 100	10 -	μA
Gate leakage current, forward	I _{GSSF}	V _{GS} =20V, V _{DS} =0V	-	-	300	nA
Gate leakage current, reverse	I _{GSSR}	V _{GS} =-20V, V _{DS} =0V	-	-	-300	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =20A T _j = 25°C	- -	0.033	0.039	Ω
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 100V, V _{GS} = 0V,	-	6070	-	pF
Output capacitance	C _{oss}	f = 1 MHz	-	220	-	
Reverse transfer capacitance	C _{rss}		-	3.5	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 300V, I _D = 30A	-	64	-	ns
Rise time	t _r	R _G = 25Ω, V _{GS} =10V	-	69	-	
Turn-off delay time	t _{d(off)}		-	307	-	
Fall time	t _f		-	56	-	
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DD} =480V, I _D =30A,	-	26.2	-	nC
Gate to drain charge	Q _{gd}	V _{GS} =0 to 10V	-	30.1	-	
Gate charge total	Q _g		-	103.0	-	
Gate plateau voltage	V _{plateau}		-	5.0	-	V
Reverse diode characteristics						
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =20A	-	-	1.2	V
Reverse recovery time	t _{rr}	V _R =50V, I _F =30A,	-	375	-	ns
Reverse recovery charge	Q _{rr}	di _F /dt=100A/μs	-	7.2	-	μC
Peak reverse recovery current	I _{rrm}		-	38	-	A

Notes:

1. Limited by T_{jmax}. Maximum duty cycle D=0.5.
2. Repetitive rating: pulse width limited by maximum junction temperature.
3. I_{AS} = 6 A, V_{DD} = 50V, R_G = 25Ω, starting T_j = 25°C.

Typical Performance Characteristics

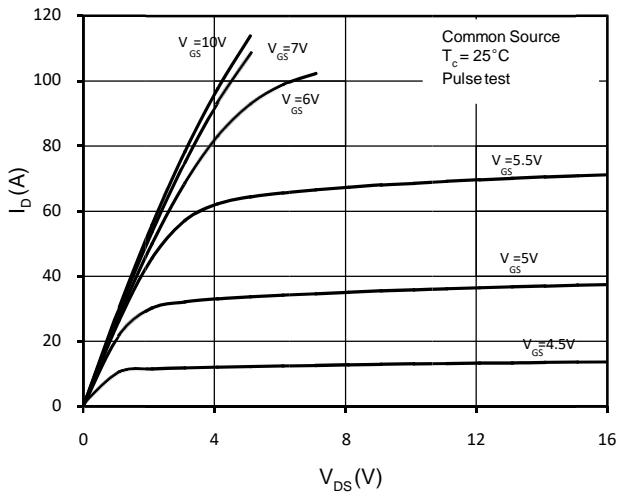


Figure 1. On-Region Characteristics

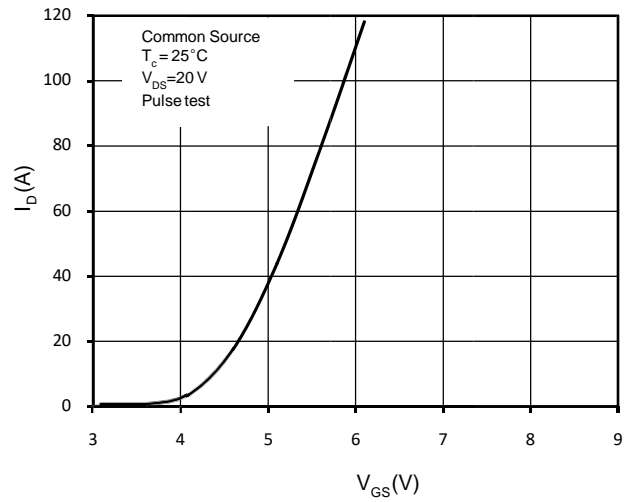


Figure 2. Transfer Characteristics

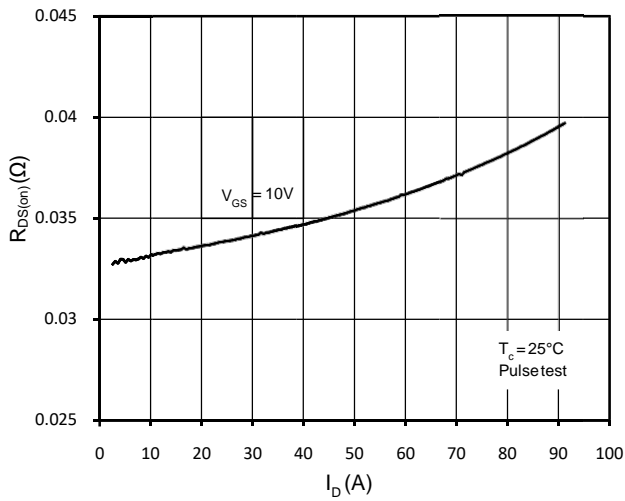


Figure 3. Static Drain-Source On Resistance

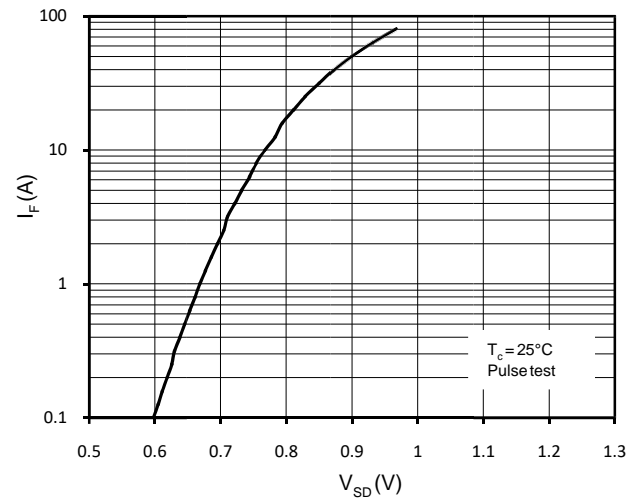


Figure 4. Body-Diode Forward Characteristics

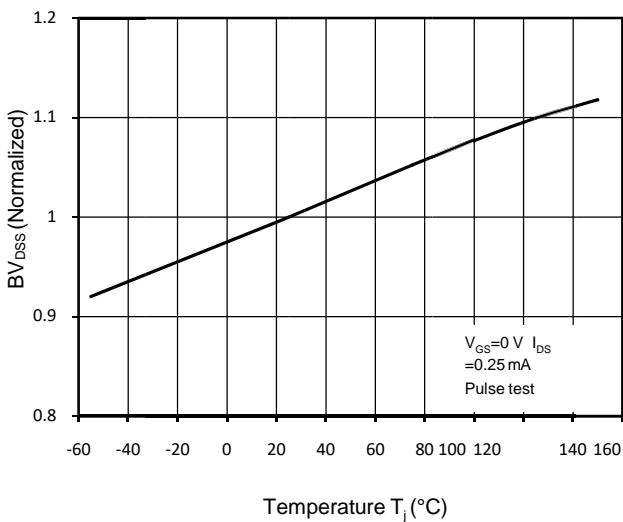


Figure 5. Normalized BV_{DS} vs. Temperature

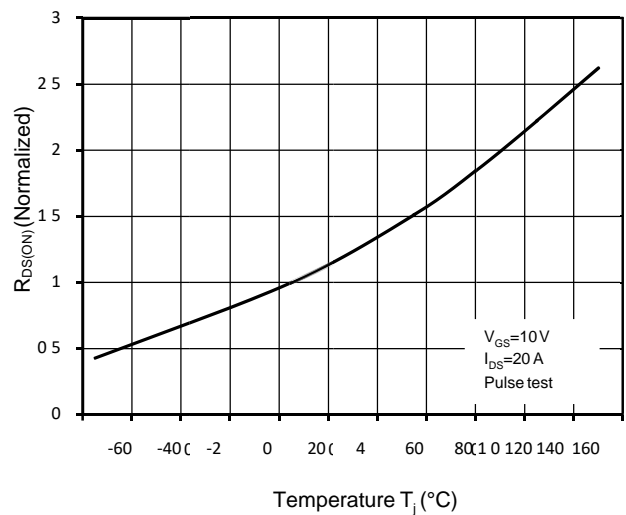


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

Typical Performance Characteristics(Con.)

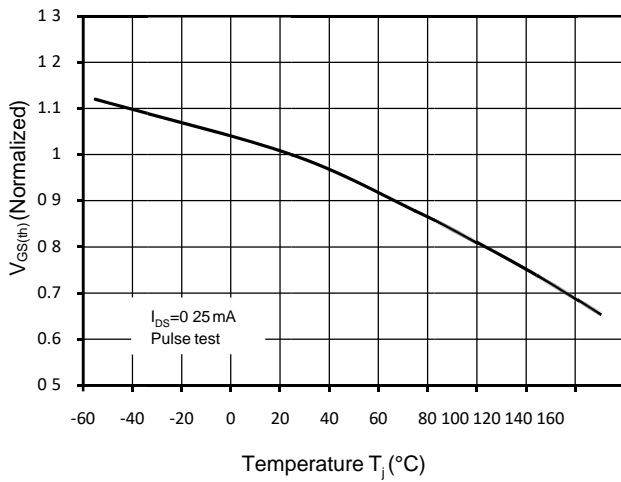


Figure 7. Threshold Voltage vs. Temperature

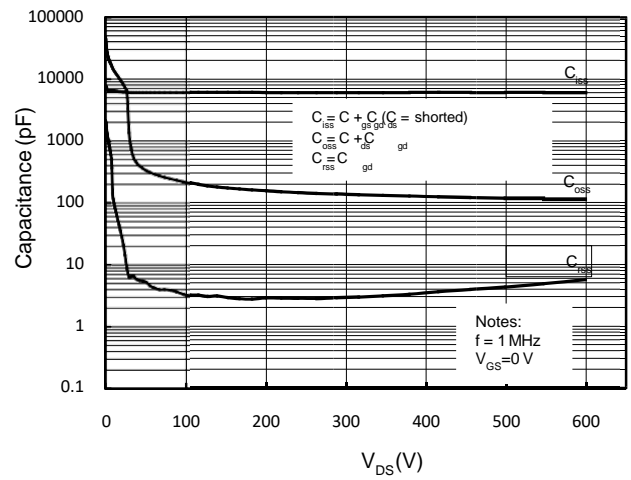


Figure 8. Capacitance Characteristics

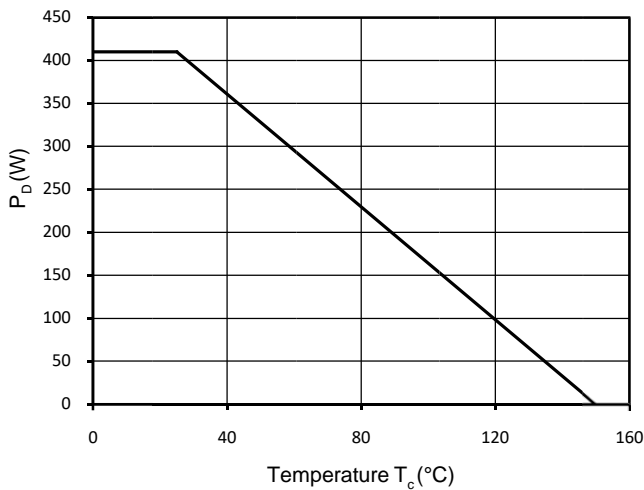


Figure 9. Power Dissipation

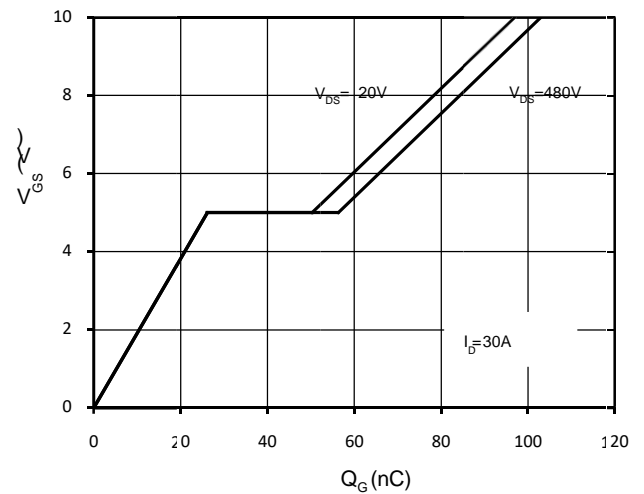


Figure 10. Gate Charge Characteristics

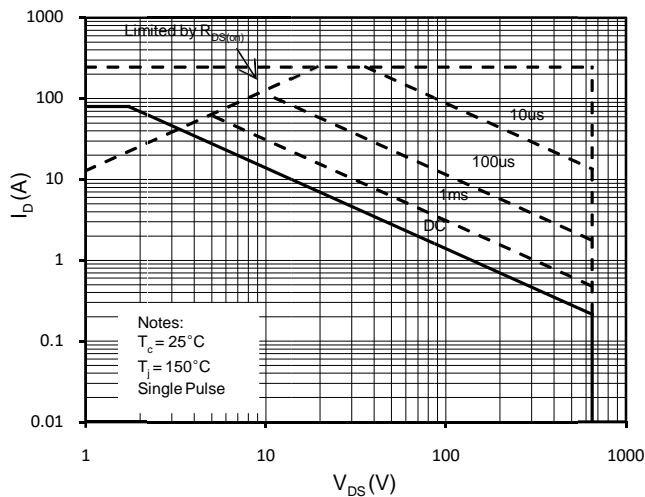


Figure 11. Maximum Safe Operating Area

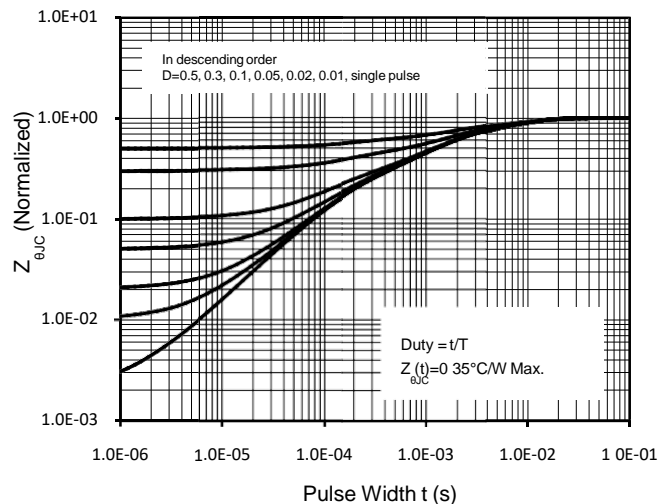
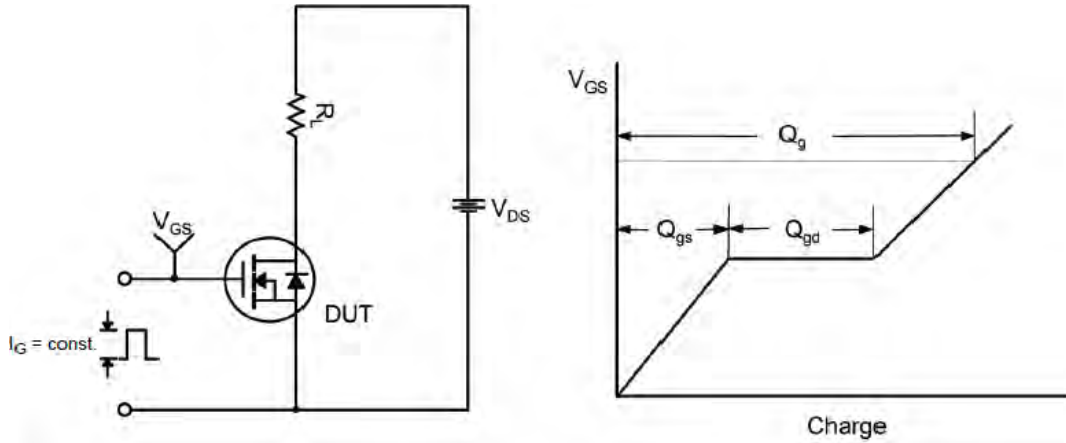
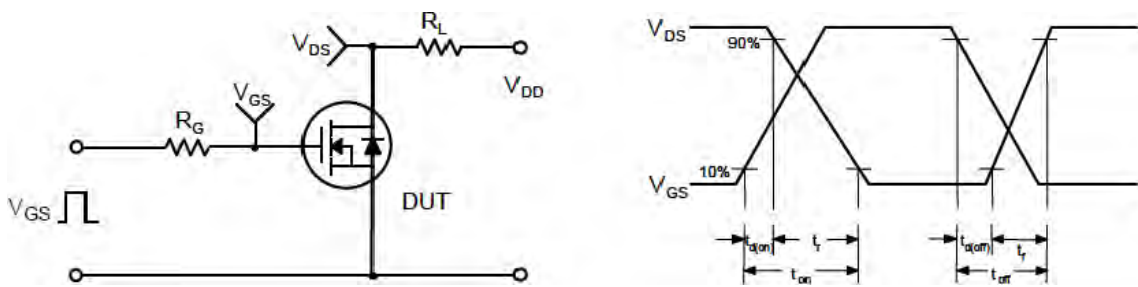


Figure 12. Transient Thermal Response Curve

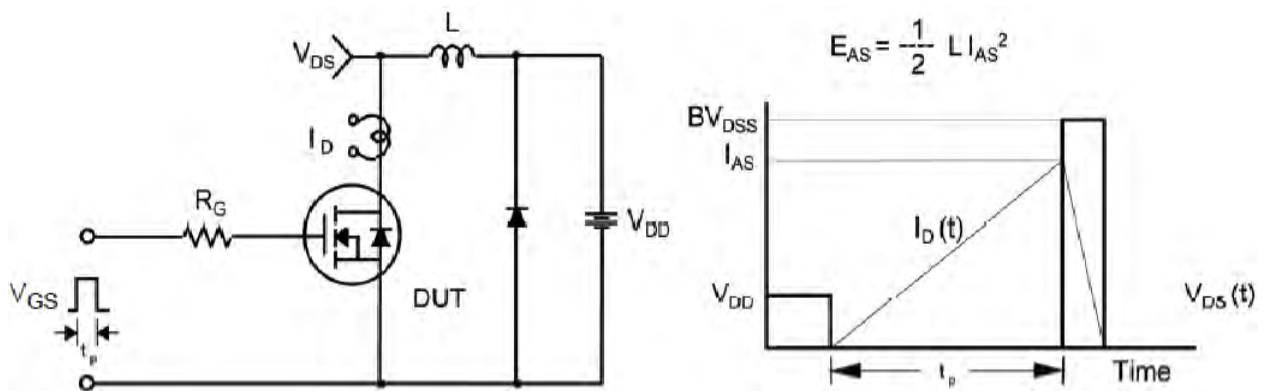
Gate Charge Test Circuit & Waveform



Switching Test Circuit & Waveforms

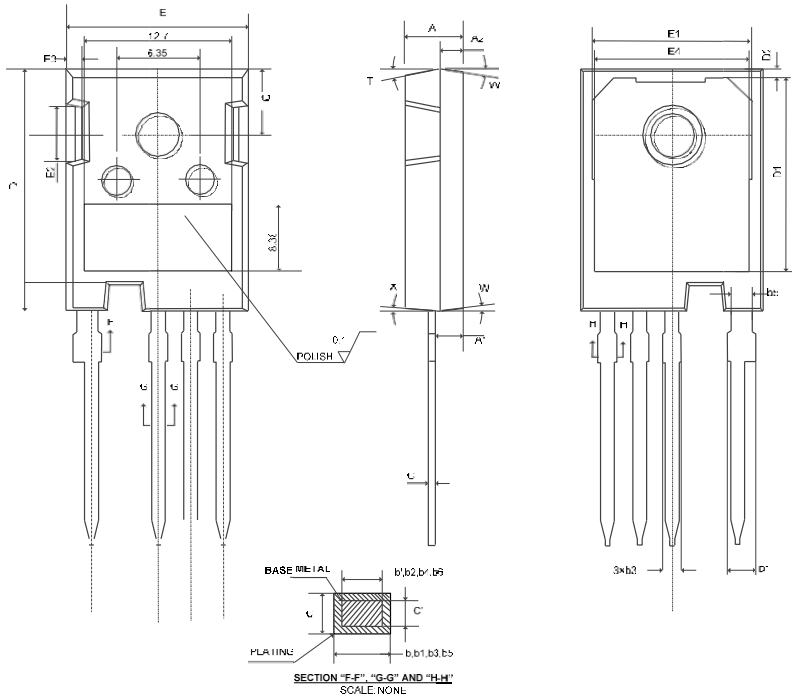


Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions for TO-247-4

COMMON DIMENSIONS



SYMBOL	mm	
	MIN	MAX
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b'	1.07	1.28
b	1.07	1.33
b1	2.39	2.94
b2	2.39	2.84
b3	1.07	1.6
b4	1.07	1.5
b5	2.39	2.69
b6	2.39	2.64
c'	0.55	0.65
c	0.55	0.68
D	23.3	23.6
D1	16.25	17.65
D2	0.95	1.25
E	15.75	16.13
E1	13.1	14.15
E2	3.68	5.1
E3	1	1.9
E4	12.38	13.43
e	2.54 BSC	
e1	5.08 BSC	
N	4	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
Q	5.49	6
T	17.5° REF	
W	3.5° REF	
X	4° REF	